

Special Issue

Additive Manufacturing of Materials: Process and Applications

Message from the Guest Editors

This Special Issue on “Additive Manufacturing of Materials: Process and Applications” seeks high-quality works focusing on the latest novel advances of additive manufacturing technologies, processes, materials and mechanisms. Topics include, but are not limited to:

- Metallic material (pure metallic materials, composite metallic materials, high-entropy alloys, etc.) process and applications;
- Non-metallic material (ceramics, polymers, biomass materials, etc.) process and applications;
- Mechanism investigations into continuous additive manufacturing, heat and mass transfer;

Guest Editors

Prof. Dr. Yanzen Zhang

Dr. Dege Li

Prof. Dr. Abhishek Agarwal

Deadline for manuscript submissions

30 November 2025



Processes

an Open Access Journal
by MDPI

Impact Factor 2.8
CiteScore 5.5



mdpi.com/si/177027

Processes
Editorial Office
MDPI, Grosspeteranlage 5
4052 Basel, Switzerland
Tel: +41 61 683 77 34
processes@mdpi.com

[mdpi.com/journal/
processes](https://mdpi.com/journal/processes)





Processes

an Open Access Journal
by MDPI

Impact Factor 2.8
CiteScore 5.5



[mdpi.com/journal/
processes](https://mdpi.com/journal/processes)



About the Journal

Message from the Editor-in-Chief

You are invited to contribute either a research article or a comprehensive review for consideration and publication in *Processes* (ISSN 2227-9717). *Processes* is published in open access format – research articles, reviews, and other content are released on the internet immediately after acceptance. The scientific community and the general public have unlimited, free access to the content. As an open access journal, *Processes* is supported by the authors and their institutes through the payment of article processing charges (APCs) for accepted papers. We would be pleased to welcome you as one of our authors.

Editor-in-Chief

Prof. Dr. Giancarlo Cravotto

Department of Drug Science and Technology, University of Turin, Via P. Giuria 9, 10125 Turin, Italy

Author Benefits

Open Access:

free for readers, with article processing charges (APC) paid by authors or their institutions.

High Visibility:

indexed within Scopus, SCIE (Web of Science), Ei Compendex, Inspec, AGRIS, and other databases.

Journal Rank:

CiteScore - Q2 (Chemical Engineering (miscellaneous))